

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	331	throgth adj wafer or through-wafer or throughwafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 15:13
L2	3089	solder adj wet\$6 or solder-wet\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 15:13
L3	3089	solder adj wet\$6 or solder-wet\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 15:14
L4	731005	nickel ni	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 15:14
L5	295	2 with 4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 15:16
L6	2	1 same (plat\$4 electro-plat\$4 electroplat\$4) same solder\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 15:59
L7	48	1 and (plat\$4 electro-plat\$4 electroplat\$4) and solder\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 15:46
L8	4237	((438/637) or (438/672) or (438/667) or (438/675) or (438/678)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/05 15:59
L9	0	8 same (plat\$4 electro-plat\$4 electroplat\$4) same solder\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 15:59

L10	332	8 and (plat\$4 electro-plat\$4 electroplat\$4) and solder\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 15:59
L11	323	10 and (@ad < "20040224")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/05 16:00